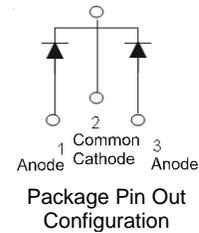


## Features

- Ultra Low Forward Voltage Drop
- Low Leakage Current
- Excellent High Temperature Stability
- Patented Super Barrier Rectifier Technology
- Soft, Fast Switching Capability
- 150°C Operating Junction Temperature
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Also Available in Green Molding Compound**
  - **Halogen and Antimony Free. "Green" Device (Note 3)**

## Mechanical Data

- Case: TO-200AB, D<sup>2</sup>Pak
- Case Material: Molded Plastic, UL Flammability Classification Rating 94V-0
- Terminals: Matte Tin Finish annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 <sup>(e3)</sup>
- Weight: TO-220AB - 1.85 grams (approximate)
- D<sup>2</sup>Pak – 1.6 grams (approximate)



## Ordering Information (Notes 4 & 5)

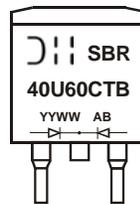
	Part Number	Case	Packaging
	SBR40U60CT	TO-220AB	50 pieces/tube
	SBR40U60CT-G	TO-220AB	50 pieces/tube
	SBR40U 60CTB	D <sup>2</sup> Pak	50 pieces/tube
	SBR40U 60CTB-13	D <sup>2</sup> Pak	800/Tape & Reel

- Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
  2. See <http://www.diodes.com> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For Green Molding Compound version part numbers, add "-G" suffix to part number above. Examples: SBR40U60CT-G.
  5. For packaging details, go to our website at <http://www.diodes.com>.

## Marking Information



SBR40U60CT = Product Type Marking Code  
 AB = Foundry and Assembly Code  
 YYWW = Date Code Marking  
 YY = Last two digits of year (ex: 07 = 2007)  
 WW = Week (01 - 53)



SBR40U60CTB = Product Type Marking Code  
 AB = Foundry and Assembly Code  
 YYWW = Date Code Marking  
 YY = Last two digits of year (ex: 12 = 2012)  
 WW = Week (01 - 53)

### Maximum Ratings (Per Leg) @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.  
 For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	$V_{RRM}$	60	V
Working Peak Reverse Voltage	$V_{RWM}$		
DC Blocking Voltage	$V_{RM}$		
Average Rectified Output Current	$I_o$	20	A
(Per Leg) (Total)		40	
Non-Repetitive Peak Forward Surge Current 8.3mS Single Half Sine-Wave Superimposed on rated load	$I_{FSM}$	280	A

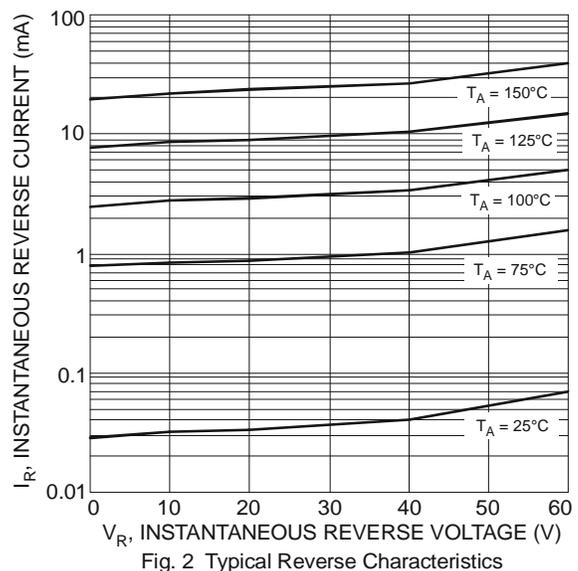
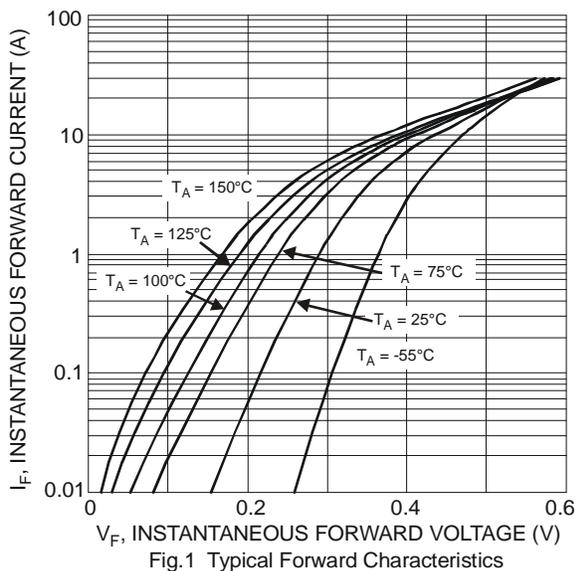
### Thermal Characteristics (Per Leg)

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Case	$R_{\theta JC}$	2	$^\circ\text{C/W}$
Operating and Storage Temperature Range	$T_J, T_{STG}$	-65 to +150	$^\circ\text{C}$

### Electrical Characteristics (Per Leg) @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop (per leg)	$V_F$	-	0.55 0.54	0.60 0.57	V	$I_F = 20\text{A}, T_J = 25^\circ\text{C}$ $I_F = 20\text{A}, T_J = 125^\circ\text{C}$
Leakage Current (Note 6)	$I_R$	-	0.07 15	0.5 100	mA	$V_R = 60\text{V}, T_J = 25^\circ\text{C}$ $V_R = 60\text{V}, T_J = 125^\circ\text{C}$

Notes: 6. Short duration pulse test used to minimize self-heating effect.



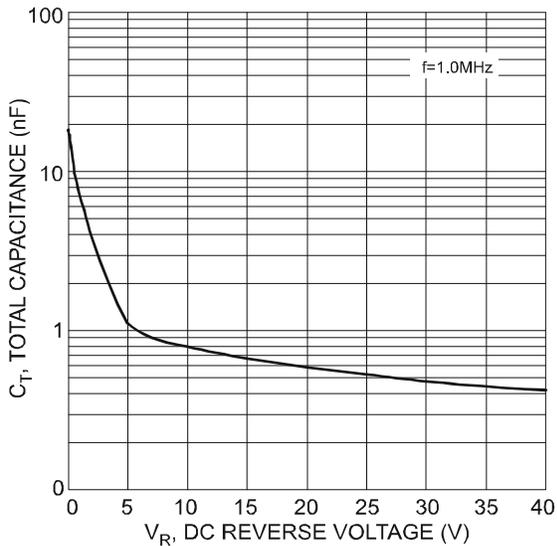


Fig. 3 Total Capacitance vs. Reverse Voltage

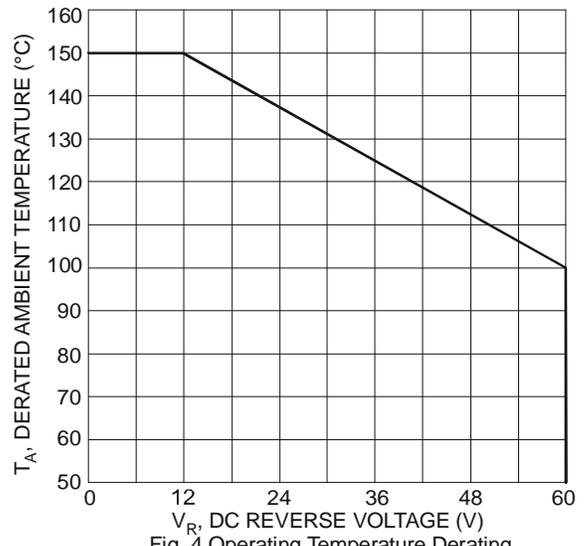
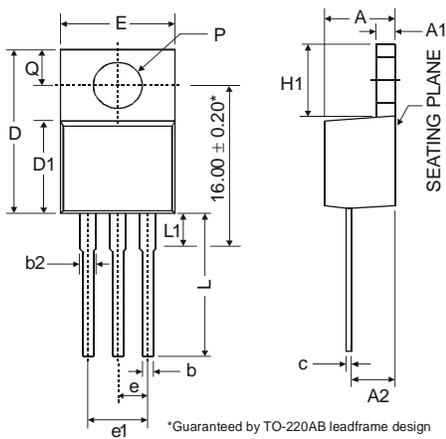
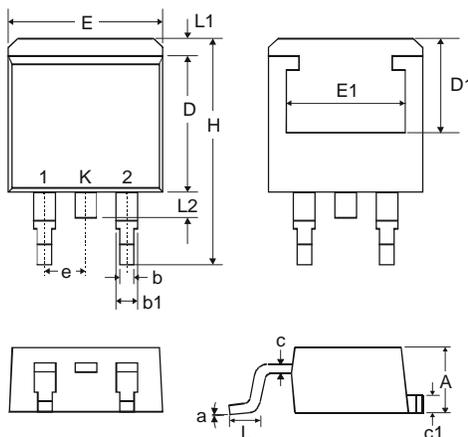


Fig. 4 Operating Temperature Derating

**Package Outline Dimensions**

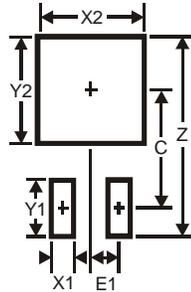


TO-220AB			
Dim	Min	Typ	Max
A	3.56	-	4.82
A1	0.51	-	1.39
A2	2.04	-	2.92
b	0.39	0.81	1.01
b2	1.15	1.24	1.77
c	0.356	-	0.61
D	14.22	-	16.51
D1	8.39	-	9.01
e	2.54		
e1	5.08		
E	9.66	-	10.66
H1	5.85	-	6.85
L	12.70	-	14.73
L1	-	-	6.35
P	3.54	-	4.08
Q	2.54	-	3.42
All Dimensions in mm			



D²PAK		
Dim	Min	Max
A	4.07	4.82
b	0.51	0.99
b1	1.15	1.77
c	0.356	0.58
c1	1.143	1.65
D	8.39	9.65
D1	6.55	—
E	9.66	10.66
E1	6.23	—
e	2.54 Typ	
H	14.61	15.87
L	1.78	2.79
L1	—	1.67
L2	—	1.77
a	0°	8°
All Dimensions in mm		

## Suggested Pad Layout



Dimensions	Value (in mm)
Z	16.9
X1	1.1
X2	10.8
Y1	3.5
Y2	11.4
C	9.5
E1	2.5

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